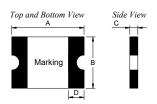
1, Physical Dimensions(size of 1812)

Unit:mm

Part Number	A		В		С		D	Maulring	
	Min	Max	Min	Max	Min	Max	Min	Marking	
KMSMD300/16	4.37	4.73	3.07	3.41	0.90	1.30	0.30	T300	



2, Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I max (A)	Ttrij (Max time Current(A)		Pd_{typ} (W)	$R_{min} (\Omega)$	$R1_{max}$ (Ω)
KMSMD300/16	3.00	6.00	16	100	8.0	5.00	1.2	0.012	0.060

I_H: Holding Current: maximum current at which the device will not trip in 25°C still air.

I_T: Tripping Current minimum current at which the device will trip in 25°C still air.

 V_{max} : Maximum voltage device can withstand without damage at rated current.

I max: Maximum fault current device can withstand without damage at rated voltage.

T_{trip}: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R min: Minimum resistance of device prior to trip at 25°C.

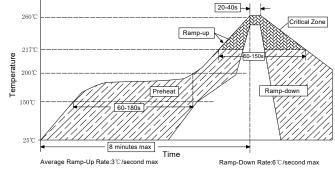
R1 max: Maximum resistance of device is measured one hours post reflow at 25°C.

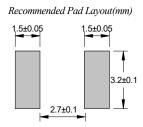
Noted: All electrical function test is conducted after PCB mounted.

3. Thermal Derating

KMSMD300/16	Maximum ambient operating temperature									
	-40°C	-20°C	0℃	25℃	40℃	50°C	60°C	70°C	85℃	
Hold Current(A)	4.40	3.90	3.50	3.00	2.60	2.30	2.10	1.80	1.50	
Trip Current(A)	8.80	7.80	7.00	6.00	5.20	4.60	4.20	3.60	3.00	

4. Solder Reflow Recommendations





Notes:If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5. Package Information

Packing quantity: 1500 PCS/Reel

Note:Reel packaging per EIA-481-1 standard

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